**Tester System**

**Testheads**  
Pullheads – 100cN – 5000 cN  
Shearheads – 500cN – 5000 cN  
Tweezerhead – 100cN

**Tester Base**

**Axes**  
- Working area X/Y-axis 100x100mm  
- Step resolution 0.25μm  
- Repeatability <2μm

**Hardware**  
- Dual Core PC, 1.6 GHz processor,  
- 4 GB RAM, Ethernet, 4x USB-Hub Front  
- Firewire CCD colour camera 1.4 MPixel  
- Network-capable with TCP / IP server

**Software**  
- Automatic repeat measurements on hybrids or COB using the programmable table movement  
- Optional pattern recognition  
- Statistics such as mean value, standard deviation, trend, cp, cpk, etc. Based on SQL Database  
- automatic calculation of the real pull forces at the bond points for standard compliant tests

**Speed**  
20 wires ≤ minute

**Dimension**  
W x D x H – 70 x 65 x 70 cm, weight approx. 80kg

**Connections**  
100-240 VAC, 1 Phase, 50/60 Hz, max 500 VA  
Ø 6mm standard vacuum tubing

**5600CS:**

The full automatic bond tester 5600CS complements F&S Bondtec Semiconductor GmbH die- and wire-bonders. The PC controlled moving table allows any number of bonds to be tested automatically from a stored program.

Results can be analysed and output immediately or exported in a number of data base formats for subsequent analysis as desired. Powerful extended capabilities enable measurements such as force/time curves to be made and deliver more data about the quality of the bond tested.

Exchangeable measurement cartridges ensure rapid conversion to different force ranges. The calibration curves of all measurement cartridges are stored internally; additional heads for shear, peel and tweezer testing with customer-specific tools and jaws are available.

After a first programming a reproducible pull- or shear test can be guaranteed for all following components.
Workholder

Standard-Workholder for parts up to 4x4" with Vacuum und mechanical clamping

Optional:

workholders up to 4x4" with jaws

TO workholder with mechanical clamping

4x4" workholder with rubberized surface and mechanical clamping

F&S Bondtec Semiconductor GmbH
Industriezeile 49a
A-5280 Braunau am Inn
Tel.: +43-7722-67052-8270
Fax: +43-7722-67052-8272
Mail: info@fsbondtec.at
Web: www.fsbondtec.at